

## Update Notification Document #: PB21821Z1

Issue Date: 27 October 2017

Title of Change:		Update to PB21821Z - List of previously announced SOT5X3 products that will not be affected by the improved cross bar tape change at ON Semiconductor Leshan, China factory.			
Effective date:		27 October 2017			
Contact information:		Contact your local ON Semiconductor Sales Office or < <a href="mailto:contact.con">Coleen.Long@onsemi.com</a> >			
Type of notification:		ON Semiconductor will consider this change accepted.			
Change category:		☐ Wafer Fab Change ☐ Assembly Change ☐ Test Change ☐ Other <u>Cross Bar of Carrier Tape Change</u>			
	Change Sub-Category(s):  Manufacturing Site Change  Manufacturing Process Ch			<ul><li>□ Datasheet/Product Doc change</li><li>☑ Shipping/Packaging/Marking</li><li>□ Other:</li></ul>	
Sites Affected: ☐ All site(s) ☐ not app		oplicable		☐ External Foundry/Subcon site(s)	
Description and Purpose:					
This Update Notice is to inform the customers of the list of SOT5X3 products that will not be affected by the change identified in the previously released PB21821Z.					
PB21821Z was previously released to announce the improved SOT5X3 cross bar of carrier tape to eliminate potential risk of unit rotate in tape.					
List of SOT5X3 Parts that were previously announced and which will not be Affected by the change:					
	SBC847CDXV6T1G	NSVEMT1DXV6T1G	NSVBC123JPDXV6T1G	NSVB143ZPDXV6T1G	NSVBA114EDXV6T1G
	SBC847BPDXV6T1G	NSVEMC2DXV5T1G	NSVBC114YPDXV6T1G	NSV12100XV6T1G	SZNUP4060AXV6T1G
	NSVT3946DXV6T1G	NSVBC144EPDXV6T1G	NSVBC114YDXV6T1G	SZQA6V8XV5T1G	NSVEMX1DXV6T1G
	NSVT3906DXV6T1G	NSVBC143ZPDXV6T1G	NSVBC114EPDXV6T1G	SZNZQA5V6AXV5T1G	
	NSVT3904DXV6T1G	NSVBC143TPDXV6T1G	NSVBC114EDXV6T1G	NSVR0320XV6T1G	
	NSVT30010MXV6T1G	NSVBC124XPDXV6T1G	NSVBA114YDXV6T1G	NSVBC124EDXV6T1G	

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